

# CIEL LIGHT CO.,LTD.

# PRODUCT SPECIFICATION

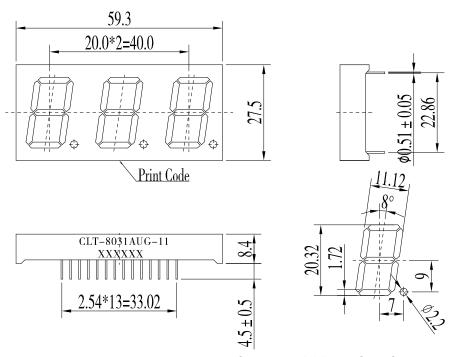
Model No.: CLT-8031AUG-11	
Drawing No.:	
Customer:	
Customer's Model No.:	
Customer's Drawing No.:	



#### Descriptions

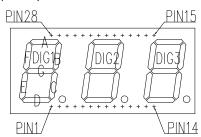
Emitting Color: Ultra Green
 Lens Color: White Diffused
 Surface Black Color: Black
 Dice Material: AlGaInP/GaAs

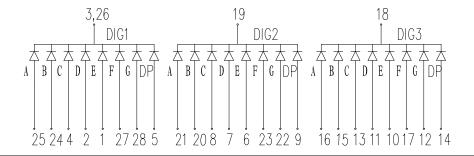
#### Outline drawing



Tolerance is  $\pm$  0.25mm unless otherwise noted , Unit=mm Pin bending  $\square$  length\*1%

#### Internal Circuit Diagram (C.C.)







#### Electrical optical characteristics ( $Ta=25^{\circ}C$ )

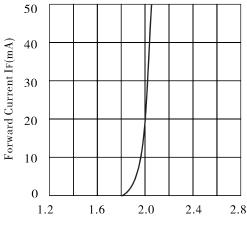
Parameter	Symbol	Ultra Green			Unit	Test Condition
T drainotor	e y moor	Min	Тур	Max	Omi	Test Condition
Forward Voltage	$\mathbf{V}_{\mathrm{F}}$		2.0	2.4	V	IF=20mA
Luminous Intensity	Ιv	7.0	13.7		med	IF=10mA
Peak Wavelength	$\lambda_{ ext{P}}$		572		nm	IF=20mA
Dominant Wavelength	$\lambda_{ m d}$		570		nm	IF=20mA
Spectral Line half–width	Δλ		20		nm	IF=20mA
Reverse Leakage Current	${ m I}_{ m R}$			50	μД	V <sub>R</sub> =5V

# Absolute Maximum Parameters ( $Ta=25^{\circ}C$ )

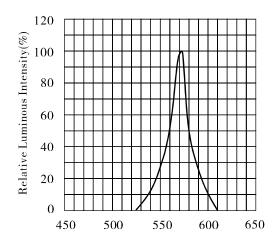
Parameter	Symbol	Test Condition Rating		Unit
Power Dissipation	$P_{D}$		60	mW
Reverse Voltage	$ m V_R$		5	V
Forward Average Current	${f I}_{f F}$		25	mA
Temperature Cofficient	I/C		0.33	mA/ €
Pulse Current	${ m I}_{ m FP}$	Duty=1/10,1kHz	100	mA
Operating Temperature Range	Topr		<b>−25 ~ +85</b>	$^{\circ}\! \mathbb{C}$
Storage Temperature Range	Tstg		−30 ~ +100	$^{\circ}\! \mathbb{C}$
Soldering Temperature	Tsd		260℃/5sec	℃



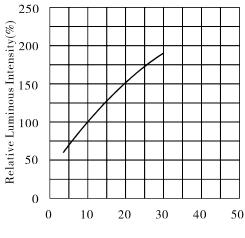
#### Typical Electro-Optical characteristic curves ( $Ta=25^{\circ}C$ )



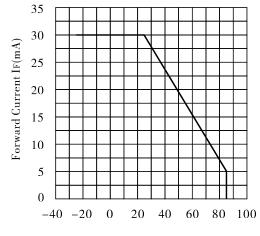




Peak Wavelength  $\lambda P (nm)$ 



Forward Current IF (mA)



Ambient Temperature  $Ta(^{\circ}C)$ 



## Reliability test conditions

Test Item	Test Condition	Result	Judgment criteria	
Consecutive operating life test	IF=20mA, T=25°C, t=168h	0/12	Forward Voltage VF(V)= Upper Limit × 1.2 Reverse Leakage Current IR(µA)=Upper Limit × 2.0 Luminous Intensity Iv (mcd)=Lower Limit × 0.7	
High temperature storage life test	T=100℃, t=168h	0/12		
Low temperature storage life test	T=−25°C, t=168h	0/12		
high Temperature humidity storage life test	T=85 ± 2°C, RH=85% ± 3, t=168h	0/12		
Temperature cycle test	-25°C~25°C~100°C, 30min 5min 30min 10cycles	0/12		
Thermal shock test	100℃ 0℃ 5min 5min 20 cycles	0/12		
Soldering heat test	$T=260 \pm 5$ °C, $t=10s \pm 1s$	0/12		
Solderability test	$T=230 \pm 5$ °C, $t=5s \pm 0.5s$	0/12	Steeped Part≥95%	
Fall test	h=100cm, Free fall, 3times	0/12		
Terminal strength test	th test W=9.8N, $t=30 \pm 5s$		Intact	
Lead Bending test	W=4.9N, 2times	0/12		